# PROCEEDINGS OF SPIE

# Micro- and Nanoelectronics 2007

Kamil A. Valiev Alexander A. Orlikovsky Editors

1–5 October 2007 Zvenigorod, Russia

Organized by

FTIAN—Institute of Physics and Technology, Russian Academy of Sciences (Russia) SPIE Russia Chapter

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Published by SPIE

Volume 7025

Proceedings of SPIE, 0277-786X, v. 7025

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Please use the following format to cite material from this book:

Author(s), "Title of Paper," in *Micro- and Nanoelectronics* 2007, edited by Kamil A. Valiev, Alexander A. Orlikovsky, Proceedings of SPIE Vol. 7025 (SPIE, Bellingham, WA, 2008) Article CID Number.

ISSN 0277-786X ISBN 9780819472380

Published by

SPIE

P.O. Box 10, Bellingham, Washington 98227-0010 USA Telephone +1 360 676 3290 (Pacific Time) Fax +1 360 647 1445 SPIE.org

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Printed in the United States of America.

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## **Contents**

xi	Conference Committees
XV	Introduction
SESSION 1	LITHOGRAPHY AND NANOLITHOGRAPHY
7025 02	Multilayer Zr/Si filters for EUV lithography and for radiation source metrology [7025-01] M. S. Bibishkin, N. I. Chkhalo, S. A. Gusev, E. B. Kluenkov, A. Ya. Lopatin, V. I. Luchin, A. E. Pestov, N. N. Salashchenko, Institute for Physics of Microstructures (Russia); L. A. Shmaenok, PhysTech (Netherlands); N. N. Tsybin, S. Yu. Zuev, Institute for Physics of Microstructures (Russia)
7025 03	Correction of the EUV mirror substrate shape by ion beam [7025-02] N. Chkhalo, L. Paramonov, A. Pestov, D. Raskin, N. Salashchenko, Institute for Physics of Microstructures (Russia)
7025 04	Investigation of fluorescence on wavelength 13.5 nm of x-ray tube for nanolithographer
	[7025-03] N. Chkhalo, I. Zabrodin, I. Kas'kov, E. Kluenkov, A. Pestov, N. Salashchenko, Institute for Physics of Microstructures (Russia)
7025 05	Manufacturing and investigation of objective lens for ultrahigh resolution lithography
	facilities [7025-04] N. I. Chkhalo, E. B. Kluenkov, A. E. Pestov, D. G. Raskin, N. N. Salashchenko, M. N. Toropov, Institute for Physics of Microstructures (Russia)
7025 06	A new source of a reference spherical wave for a point diffraction interferometer [7025-05] N. I. Chkhalo, A. Yu. Klimov, D. G. Raskin, V. V. Rogov, N. N. Salashchenko, M. N. Toropov, Institute for Physics of Microstructures (Russia)
7025 07	A plane wave diffraction on a pin-hole in a film with a finite thickness and real
	electrodynamic properties [7025-06] N. I. Chkhalo, I. A. Dorofeev, N. N. Salashchenko, M. N. Toropov, Institute for Physics of Microstructures (Russia)
7025 08	Mask image formation by electron beam deposition from vapor phase [7025-07] M. A. Bruk, Karpov Institute of Physical Chemistry (Russia); E. N. Zhikharev, S. L. Shevchuk, Institute of Physics and Technology (Russia); I. A. Volegova, A. V. Spirin, E. N. Teleshov, Karpov Institute of Physical Chemistry (Russia); V. A. Kalnov, Yu. P. Maishev, Institute of Physics and Technology (Russia)

SESSION 2	PLASMA AND BEAM PROCESSING				
7025 09	Focused ion beam source of a new type for micro- and nanoelectronics technologies (Invited Paper) [7025-08] V. L. Varentsov, V.G. Khlopin Radium Institute (Russia)				
7025 0A	Measurement of atomic hydrogen flow density during GaAs surface cleaning [7025-09] V. A. Kagadei, E. V. Nefyodtsev, D. I. Proskurovski, S. V. Romanenko, Institute of High Current Electronics (Russia)				
7025 OB	Investigation of impurity composition of atomic hydrogen beam formed by a low-pressure arc-discharge source [7025-10] V. A. Kagadei, D. I. Proskurovski, S. V. Romanenko, Institute of High Current Electronics (Russia)				
7025 0C	Theoretical study of ionization processes in BF3 plasma [7025-11] V. P. Kudrya, Institute of Physics and Technology (Russia)				
7025 0D	Reactive sputtering of metal targets: influence of reactive atoms implantation [7025-12] V. A. Marchenko, Institute of Microelectronics Technology and High Purity Materials (Russia)				
7025 OE	Effect of quartz window temperature on plasma composition during STI etch [7025-13] E. V. Danilkin, IMEC vzw (Belgium), MIKRON (Russia), and Moscow Institute of Electronic Technology (Russia); D. Shamiryan, M. R. Baklanov, A. P. Milenin, W. Boullart, IMEC vzw (Belgium); G. Y. Krasnikov, O. P. Gutshin, MIKRON (Russia); A. I. Mochalov, Moscow Institute of Electronic Technology (Russia)				
7025 OF	Langmuir probe applications in monitoring of plasma etching [7025-14] A. V. Miakonkikh, K. V. Rudenko, A. A. Orlikovsky, Institute of Physics and Technology (Russia)				
7025 0G	An end point detection method based on induced current and an automatic control device for an ion etching system [7025-15] S. B. Simakin, Scientific Research Institute of Vacuum Technique (Russia); G. D. Kuznetsov, Moscow State Institute of Steel and Alloys (Russia); E. A. Mitrofanov, Scientific Research Institute of Vacuum Technique (Russia)				
7025 OH	The method of thin metal films adhesion increasing for the lowered dimensions structures [7025-16] N. L. Kazanskiy, Image Processing Systems Institute (Russia); V. A. Kolpakov, V. D. Paranin, M. S. Polikarpov, Samara State Aerospace Univ. (Russia)				
SESSION 3	MATERIALS AND DEVICES FOR OPTOELECTRONICS				
7025 01	Surprising phase transformation of a-Si:H films under femtosecond laser impact [7025-17] V. A. Volodin, Institute of Semiconductor Physics (Russia) and Novosibirsk State Univ. (Russia); M. D. Efremov, G. A. Kachurin, S. A. Kochubei, A. G. Cherkov, Institute of Semiconductor Physics (Russia); M. Deutschmann, N. Baersch, Laser Zentrum Hannover (Germany)				

7025 OJ	Micro-scale domain structure formation by e-beam point writing on the Y cut surfaces of LiTaO <sub>3</sub> crystals [7025-18] L. S. Kokhanchik, D. V. Punegov, Institute of Microelectronics Technology and High Purity
	Materials (Russia)
7025 OK	Intersubband optical transitions in InAs/GaSb broken-gap quantum wells [7025-19] I. Semenikhin, A. Zakharova, Institute of Physics and Technology (Russia); K. Nilsson, Lund Univ. (Sweden); K. A. Chao, Linköping Univ. (Sweden)
7025 OL	Silicon avalanche photodiodes for particle detection [7025-20]  I. B. Chistokhin, O. P. Pchelyakov, E. G. Tishkovsky, V. I. Obodnikov, Institute of Semiconductor Physics (Russia); V. V. Maksimov, A. A. Ivanov, Budker Institute of Nuclear Physics (Russia); E. Gramsch, Univ. de Santiago (Chile)
SESSION 4	NANOSCTRUCTURES AND NANODEVICES
7025 0M	Graphene nanoelectronics: electrostatics and kinetics [7025-21] G. I. Zebrev, Moscow Engineering Physics Institute (Russia)
7025 ON	The method for the determination of electrical self-capacitance of the atomic and molecular scale objects [7025-22] V. V. Shorokhov, E. S. Soldatov, V. G. Elenskiy, Moscow State Univ. (Russia)
7025 00	Effects of spatial reproduction at the interference of the electron waves in semiconductor 1D nanostructures with parabolic quantum wells [7025-23] V. A. Petrov, A. V. Nikitin, Institute of Radio Engineering and Electronics (Russia)
7025 OP	Method of creation of monomolecular transistor with overhanging electrodes [7025-24] I. V. Sapkov, E. S. Soldatov, V. G. Elensky, Moscow State Univ. (Russia)
7025 0Q	Creation of nanometer gaps between thin-film metal electrodes by the method of electromigration [7025-25]  A. N. Kuturov, E. S. Soldatov, A. S. Stepanov, M.V. Lomonosov Moscow State Univ. (Russia)
7025 OR	Pulsed laser deposition of layers and nanostructures based on cadmium telluride and bismuth [7025-26] A. Yeremyan, H. Avetisyan, K. Avjyan, G. Vardanyan, A. Khachatryan, Institute of Radiophysics and Electronics (Armenia)
SESSION 5	MAGNETIC MICRO- AND NANOSTRUCTURES
7025 OS	Non-equilibrium magnetism of nanoparticles revealed in static and radiofrequency measurements [7025-27] M. A. Chuev, N. P. Aksenova, P. G. Medvedev, A. M. Afanas'ev, Institute of Physics and Technology (Russia)
7025 OT	Finite size effects in antiferromagnetic multilayers [7025-28] V. V. Kostyuchenko, Institute of Physics and Technology (Russia); M. V. Kostyuchenko, Yaroslavl State Technical Univ. (Russia)

#### 7025 0U Epitaxial Fe films and structures [7025-29]

I. V. Malikov, L. A. Fomin, V. Yu. Vinnichenko, G. M. Mikhailov, Institute of Microelectronics Technology and High Purity Materials (Russia)

## 7025 0V Investigation of re-switching properties of ferromagnetic contacts in Py/Mo microstructures

[7025-30]

V. Yu. Vinnichenko, A. V. Chernykh, L. A. Fomin, G. M. Mikhailov, Institute of Microelectronics Technology and High Purity Materials (Russia)

#### SESSION 6 THIN FILMS TECHNOLOGIES

## 7025 0W Molecular-beam epitaxy of ultrathin Si films on sapphire [7025-31]

P. A. Shilyaev, D. A. Pavlov, E. V. Korotkov, M. V. Treushnikov, Univ. of Nizhny Novgorod (Russia)

## 7025 0X Formation of TiN/CoSi<sub>2</sub> bilayer from Co/Ti/Si structure in a non-isothermal reactor [7025-32]

V. I. Rudakov, V. N. Gusev, Institute of Physics and Technology (Russia)

## 7025 0Y Formation of thin ZrO<sub>2</sub> layers for nanotransistor gate structures by electron beam evaporation [7025-33]

D. G. Drozdov, Moscow State Institute of Radioengineering, Electronics and Automation (Russia); I. A. Khorin, Institute of Physics and Technology (Russia) and Moscow State Institute of Radioengineering, Electronics and Automation (Russia); V. B. Kopylov, A. A. Orlikovsky, A. E. Rogozhin, Institute of Physics and Technology (Russia); A. G. Vasiliev, Institute of Physics and Technology (Russia) and Pulsar Science and Production Enterprise (Russia)

## 7025 0Z Films with regulated optical and electrophysical parameters [7025-34]

A. E. Akinin, I. S. Borisov, V. V. Chernokogin, Y. A. Kontsevoy, Pulsar Science Research Institute (Russia); E. A. Mitrofanov, S. B. Simakin, Scientific Research Institute of Vacuum Technique (Russia); Y. A. Zavadsky, Pulsar Science Research Institute (Russia)

### SESSION 7 MICRO- AND NANOSTRUCTURES CHARACTERIZATION

## 7025 10 Direct measurement of the linewidth of relief element on AFM in nanometer range [7025-35]

Yu. A. Novikov, A.M. Prokhorov General Physics Institute (Russia); M. N. Filippov, N.S. Kurnakov Institute of General and Inorganic Chemistry (Russia); I. D. Lysov, Moscow Institute of Physics and Technology (Russia); A. V. Rakov, A.M. Prokhorov General Physics Institute (Russia); V. A. Sharonov, Moscow Institute of Physics and Technology (Russia); P. A. Todua, Ctr. for Surface and Vacuum Research (Russia)

Nanorelief elements in reference measures for scanning electron microscopy [7025-36] Yu. A. Novikov, A.M. Prokhorov General Physics Institute (Russia); S. A. Darznek, Ctr. for Surface and Vacuum Research (Russia); M. N. Filippov, N.S. Kurnakov Institute of General and Inorganic Chemistry (Russia); V. B. Mityukhlyaev, Ctr. for Surface and Vacuum Research (Russia); A. V. Rakov, A.M. Prokhorov General Physics Institute (Russia); P. A. Todua, Ctr. for Surface and Vacuum Research (Russia)

7023 12	objects with sub-nanometer resolution [7025-37] N. I. Chkhalo, D. G. Raskin, N. N. Salashchenko, Institute for Physics of Microstructures (Russia)
7025 13	Falling down capacitance impedance under light illumination of MDS structures with three-layer SiN <sub>x</sub> dielectrics [7025-38] S. A. Arzhannikova, M. D. Efremov, V. A. Volodin, G. N. Kamaev, D. V. Marin, V. S. Shevchuk,
	A. A. Vaschenkov, S. A. Kochubei, Institute of Semiconductor Physics (Russia); A. A. Popov, Y. A. Minakov, Institute of Microelectronics and Informatics (Russia)
7025 14	Al <sub>x</sub> Ga <sub>(1-x)</sub> N/GaN structure diagnostic by C-V characteristics method [7025-39] K. L. Enisherlova, I. B. Gulyaev, V. G. Goryachev, A. U. Dorofeev, E. M. Temper, N. B. Gladisheva, Pulsar Science and Production Enterprise (Russia)
7025 15	The new approach in the determination of the dependency of surface charge density on semiconductor surface potential based voltage: capacity analysis of the depletion region of MIS structures [7025-40]
	G. V. Chucheva, A. G. Zhdan, Institute of Radio Engineering and Electronics (Russia)
SESSION 8	DEVICE STRUCTURES AND ICs
7025 16	Parasitic bipolar effect in modern SOI CMOS technologies [7025-41] V. E. Shunkov, M. S. Gorbunov, Moscow Engineering Physical Institute (Russia) and Scientific Research Institute for System Studies (Russia); G. I. Zebrev, Moscow Engineering Physical Institute (Russia); B. V. Vasilegin, Scientific Research Institute for System Studies (Russia)
7025 17	Radiation induced leakage due to stochastic charge trapping in isolation layers of nanoscale MOSFETs [7025-42] G. I. Zebrev, M. S. Gorbunov, V. S. Pershenkov, Moscow Engineering Physics Institute (Russia)
7025 18	The spatial features Al <sub>x</sub> Ga <sub>1-x</sub> N/GaN heterostructure [7025-43] K. L. Enisherlova, Pulsar Science Research Institute (Russia); R. M. Immamov, I. M. Subbotin, Institute of Crystallography (Russia); T. F. Rusak, E. M. Temper, Pulsar Science Research Institute (Russia)
7025 19	Features of evolution of implanted profiles during RTA in non-isothermal reactor [7025-44] V. I. Rudakov, A. A. Victorov, Y. I. Denisenko, B. V. Mochalov, V. V. Ovcharov, Institute of Physics and Technology (Russia)
7025 1A	Stable silicon resistors at 20–160° C due to divacancy involving high purity neutron doped \$i [7025-45]
	G. N. Kamaev, M. D. Efremov, V. A. Stuchinsky, B. I. Mikhailov, S. G. Kurkin, Institute of Semiconductor Physics (Russia)
7025 1B	<b>Sign magnetosensitivity of dual-collector lateral bipolar magnetotransistor</b> [7025-46] R. D. Tikhonov, SMC Technological Ctr. MIEE (Russia)

7025 1C	Research of the disbalance mechanism of dual collector lateral bipolar magnetotransistor [7025-47] R. D. Tikhonov, S. A. Polomoshnov, SMC Technological Ctr. MIEE (Russia); A. V. Kozlov, A. Ju. Krasukov, Moscow Institute of Electronic Technology (Russia)
7025 1D	Non-volatile electrically reprogrammable memory matrix on self-forming conducting nanostructures with an integrated transistor electric decoupling of cells [7025-48] V. M. Mordvintsev, S. E. Kudrjavtsev, V. L. Levin, L. A. Tsvetkova, Institute of Physics and Technology (Russia)
SESSION 9	MEMS AND NEMS
7025 1E	High energy microelectromechanical oscillator based on the electrostatic microactuator [7025-49]  I. Baginsky, E. Kostsov, V. Sobolev, Institute of Automation and Electrometry (Russia)
7025 1F	Divergence instability of an extensible microplate subjected to nonlinear electrostatic pressure [7025-50] G. Rezazadeh, H. Yagubizade, Urmia Univ. (Iran); Y. Alizadeh, Arak Azad Univ. (Iran)
7025 1G	Electromechanical energy conversion in the nanometer gaps [7025-51] E. G. Kostov, Institute of Automation and Electrometry (Russia)
7025 1H	Simulation, fabrication, and dynamics characteristics of electrostatically actuated switches [7025-52] A. V. Postnikov, I. I. Amirov, V. V. Naumov, Institute of Microelectronics and Informatics (Russia); V. A. Kalnov, Institute of Physics and Technology (Russia)
SESSION 10	SIMULATION AND MODELING
7025 11	Comparative analysis of pseudo-potential and tight-binding band structure calculations with an analytical two-band k•p model: conduction band of silicon [7025-53] V. A. Sverdlov, Technische Univ. Wien (Austria) and State Univ. of St. Petersburg (Russia); H. Kosina, S. Selberherr, Technische Univ. Wien (Austria)
7025 1J	Physically based simulation of fully depleted SOI MOS transistors at nanometer gate lengths [7025-54]  A. Burenkov, C. Kampen, J. Lorenz, H. Ryssel, Fraunhofer Institute of Integrated Systems and Device Technology (Germany)
7025 1K	All-quantum simulation of an ultra-small SOI MOSFET [7025-55] V. Vyurkov, I. Semenikhin, V. Lukichev, Institute of Physics and Technology (Russia); A. Burenkov, Fraunhofer Institute of Integrated Systems and Device Technology (Germany); A. Orlikovsky, Institute of Physics and Technology (Russia)
7025 1L	Monte Carlo study of influence of channel length and depth on electron transport in SOI MOSFETs [7025-56] O. Zhevnyak, V. Borzdov, A. Borzdov, D. Pozdnyakov, F. Komarov, Belarus State Univ. (Belarus)

7025 1M	Temperature effect on electron transport in conventional short channel MOSFETs: Monte Carlo simulation [7025-57] O. Zhevnyak, Belarus State Univ. (Belarus)
7025 1N	Modeling of powerful GaAs MESFET [7025-58] A. Shestakov, A. Myasnikov, K. Zhuravlev, Institute of Semiconductor Physics (Russia)
7025 10	Modeling of vertical transistor with electrically variable junctions in ISE TCAD [7025-59]  A. E. Rogozhin, I. A. Khorin, Institute of Physics and Technology (Russia); D. G. Drozdov, Moscow State Institute of Radioengineering, Electronics and Automation (Russia);  A. G. Vasiliev, Institute of Physics and Technology (Russia) and Pulsar Science and Production Enterprise (Russia)
7025 1P	A comparison of fitness function evaluation schedules for multi-objective univariate marginal distribution optimization of mixed analog-digital signal circuits [7025-60] L. Zinchenko, M. Radecker, F. Bisogno, FhG IAIS (Germany)
7025 1Q	A new model for the copper CMP kinetics [7025-61] R. Goldstein, Institute for Problems in Mechanics (Russia); T. Makhviladze, M. Sarychev, Institute of Physics and Technology (Russia)
7025 1R	Influence of vacancy clusters on the adhesion properties of interfaces [7025-62] R. Goldstein, Institute for Problems in Mechanics (Russia); T. Makhviladze, M. Sarychev, Institute of Physics and Technology (Russia)
7025 1\$	Modeling of non-stationary electron transport in semiconductor nanowires and carbon nanotubes [7025-63]  D. Pozdnyakov, A. Borzdov, V. Borzdov, F. Komarov, Belarusian State Univ. (Belarus)

Author Index

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## Introduction

This volume contains selected papers from those presented at the International Conference on Micro- and Nanoelectronics 2007 (ICMNE-2007), held in Zvenigirod, Moscow region, 1–5 October 2007. The conference is a regular forum with international status and continues the series of biannual conferences on physical and technological problems in microelectronics. Since 1992, the Institute of Physics and Technology of the Russian Academy of Sciences (FTIAN) has been a permanent organizer of the ICMNE conferences. Since 2003, the ICMNE has been a SPIE-affiliated conference. ICMNE-2007 was supported by the Russian Academy of Sciences, Russian Foundation of Basic Research, and Russian Ministry of Education and Sciences, with the help of SPIE Russia Chapter.

The goals of the conference are threefold: anticipating new concepts and technologies of integrated devices, understanding their potential for nanoelectronics development, and joining the efforts of scientists in meeting the challenges of industry scaling down ICs to nanometer design rules. ICMNE-2007 featured a wide scope of presented papers in the fields of the physics of microand nanostructures, techniques for its characterization, and bottleneck points in the technologies of micro- and nanoscale devices.

The Conference focused on topical problems that were highlighted in the following sessions:

- Lithography and Nanolithography
- Plasma and Beam Processing
- Materials and Devices for Optoelectronics
- Nanostructures and Nanodevices
- Magnetic Micro- and Nanostructures
- Thin Films Technologies
- Micro- and Nanostructures Characterization
- Device Structures and ICs
- MEMS and NEMS, and
- Simulation and Modeling.

The scientific program comprised a strong collection of invited and contributed papers from scientists employed at European and Siberian Regions of Russia, Eastern and Western Europe, and Asia. The invited lectures on urgent microelectronic problems delivered by the scientists from France, Belgium, USA, United Kingdom, Japan, and Russia at the Plenary Session aroused significant interest of the audience. The contributions came from academic institutions, universities, and industry. More than 90 papers were discussed as oral presentations; the others were presented as posters.

We hope that discussion of these papers both during the sessions of the Conference and during personal contacts outside the sessions will promote further research activity in the microelectronic community.

Additional information about ICMNE can be found at the conference website <a href="http://www.icmne.ftian.ru">http://www.icmne.ftian.ru</a>

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